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Improvement of the ferroelectric properties of ABO_3 (A = Pb, Ca, Ba; B = Ti, Zr) films

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Abstract

High-quality $ABO_3/LaNiO_3$ (A = Pb, Ca, Ba; B = Ti, Zr) heterostructures have been grown on $LaAlO_3$ (100) substrate by the chemical solution deposition method and crystallized by a microwave oven technique. The structural, morphological and electric properties were characterized by means of X-ray diffraction (XRD), atomic force microscope (AFM), and dielectric and ferroelectric measurements. XRD patterns revealed single-phase polycrystalline and oriented thin films whose feature depends on the composition of the films. The AFM surface morphologies showed a smooth and crack-free surface with the average grain size ranging from 116 to 300 nm for both LaNiO₃ electrode and the ferroelectric films. Dielectric measurements on these samples revealed dielectric constants as high as 1800 at frequency of 100 KHz. Such results showed that the combination of the chemical solution method with the microwave process provides a promising technique to grow high-quality thin films with good dielectric and ferroelectric properties.

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Keywords: Films; Chemical solution deposition method; Ferroelectric properties; Perovskites; BaTiO₃ and titanates

1. Introduction

The development of ferroelectric thin film technology has been extensively investigated due to the possibility of application in integrated electronic circuits as, for example, ferroelectric random access memories (FeRAMs).^{1,2} In order to improve the dielectric constant and to produce fatigue-free ferroelectric thin films, several works reported on the influence of preparation conditions and the conductive electrode effect on the physical properties of ferroelectric thin films.^{3–7}

In this context, several studies have been dedicated to the ferroelectric films grown on conductive oxides electrodes such as LaNiO₃, SrRuO₃, BaPbO₃, and Yba₂Cu₃O_{7- δ}. These oxides were used to replace the Pt bottom electrode that usually presents serious fatigue problems.^{8,9} Between these con-

ductive oxides, the most widely investigated has been the LaNiO₃, mainly due its metallic behavior until temperatures close to 4.2 K and its crystallographic compatibility with the perovskite structure of the ferroelectrics.^{10–12} At the same time the study of the growth of epitaxial or high-oriented thin films have been successfully to reach ferroelectric films with better properties than the polycrystalline one.^{13,14} Attempts have been made to enhance the crystallization ability of ferroelectric thin films and metallic oxide electrode. In this sense, a new way to synthesize these materials have been searched as, for example, the use of microwave frequency source of energy to annealing those ferroelectric films.^{15,16} This procedure have produced materials with high degree of crystallinity and at lower annealing processing time. Also, it decreases the interfacial reactions between the ferroelectric film and the bottom electrode, which provide a better control of the crystallographic orientation of the thin film.

Another important point, regarding the production of ferroelectric thin films, concerns the method to produce such film. There are several techniques for synthesizing thin films and the more widely studied are r.f. sputtering, laser abla-

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Fig. 1. X-ray patterns of (a) LaAlO₃ substrate; (b) LaNiO₃ thin film on the substrate; (c) $Pb_{0.8}Ba_{0.2}TiO_3$ thin film on LaNiO₃/LaAlO₃ (100); $Pb_{0.6}Ca_{0.4}TiO_3$ thin film on LaNiO₃/LaAlO₃ (100); and (e) $PbZr_{0.30}Ti_{0.70}O_3$ thin film on LaNiO₃/LaAlO₃ (100). S, substrate peak.

tion deposition and chemical methods (sol–gel, metallorganic chemical vapor deposition, soft chemical deposition). Among those methods, the soft chemical deposition method has provide the production of high-quality oriented films, when the film was controlled annealed in a microwave oven.¹⁵

In this work, we reported on the preparation of highly (100) oriented $Pb_{1-x}A_xTi_{1-y}B_yO_3$ (A = Ba, Ca; B = Zr) and LaNiO₃ thin films by a soft chemical solution deposition method. These films were grown on LaAlO₃ (100) substrate and heat-treated in a domestic microwave oven at 700 °C for few minutes.

2. Experimental procedure

The Pb_{1-x}A_xTi_{1-y}B_yO₃/LaNiO₃ (A = Ca, Ba; B = Zr) thin films were produced by chemical solution deposition CSD method.¹² Through this method, a polymeric resin of both ABO₃ and LaNiO₃ were separated produced by means of the CSD route. The LaNiO₃ and Pb_{1-x}A_xTi_{1-y}B_yO₃ films were deposited by spin coated technique on LaAlO₃ (100) substrate, as described elsewhere.^{12,15} Then, they were dried, and annealed at ~300 °C for 6 h in a conventional furnace and were sintered at 600 and 700 °C in a microwave oven for 10 min. The structural features of these thin films were characterized by X-ray diffraction (XRD) measurements, which were performed in all samples by using the Cu K α radiation on a Rigaku D/Max-2400 diffractometer. Typical 2 θ angular scans ranging from 20 to 60° in steps varying of 0.02° were used in these experiments. Changes in the morphology of ABO₃/LaNiO₃ heterostructures were analyzed by means



Fig. 2. AFM micrographs of the (a) Pb_{0.8}Ba_{0.2}TiO₃ thin films; (b) Pb_{0.6}Ca_{0.4}TiO₃ thin film; and (c) PbZr_{0.30}Ti_{0.70}O₃ thin film. S represents the substrate peaks.

of Atomic force microscopy (AFM). The images were analyzed using the Digital Instruments Multimode Nanoscope IIIa (Santa Barbara, CA) software. The film thickness was evaluated observing the cross-section of the films using a Zeiss DSM940A scanning electron microscopy (SEM). The dielectric properties were measured on films in a metal-thin film-metal configuration using a HP4192A impedance/gain phase analyzer. All the measurements were conducted at room temperature.

3. Discussion and results

Fig. 1 displays X-ray diffraction patterns for: (a) LaAlO₃ substrate; (b) conductive oxide LaNiO₃/LaAlO₃, also called LNO/LAO; (c) Pb_{0.8}Ba_{0.2}TiO₃/LNO/LAO; (d) $Pb_{0.6}Ca_{0.4}TiO_3/LNO/LAO$; and (e) $PbZr_{0.3}Ti_{0.7}O_3/$ LNO/LAO. For a better understanding, these films are thereafter called PBT8020; PCT6040, and PZT3070, respectively. It can be seen that the LaNiO₃ thin film electrode annealed at 700 °C, for 10 min, crystallizes in a perovskite and is highly (100) oriented, which is feature of the intense peak at $2\theta \sim 23^{\circ}$. Also, it should be noticed that the low intense reflection at $2\theta \sim 32.7^{\circ}$ belongs to the polycrystalline LaNiO₃ phase. The Fig. 2(c) revealed a highly oriented PBT8020 thin film deposited on LNO/LAO, where the intensities of the (100) and (200) peaks are stronger than those (101)and (110) Bragg reflections, which suggested that this films is highly (100) oriented in the PBT8020 perovskite phase. X-ray pattern of the PCT6040 thin film presents a similar behavior (see Fig. 1(d)) and also presented a low intense peak at $2\theta \sim 32.4^{\circ}$ that are addressed to the (101)/(110)Bragg planes of the polycrystalline phase. The Fig. 1(e) displays a single-phase polycrystalline X-ray diffraction pattern for the PZT3070, as this measurement have been performed after the electrical characterization, this pattern also show peaks from the gold electrodes. In general, we believed that the production of highly oriented (100) LaNiO₃ thin films should be a result of the enhanced crystallization and interfacial growth improvement of the thin films, which were influenced by the microwave treatment and by the matching of the lattice parameters of the LNO and ABO3 thin film.

The surface morphologies for the LNO/LAO, PBT8020, PCT6040, and PZT3070 thin films were observed by AFM images, as are shown in Fig. 2. The films were found to have smooth surfaces, crack-free, and we have found no evidence of droplet on them. An analysis on these images revealed an average surface roughness $R_{\rm rms}$ value of ~9 nm, while the average grains sizes *t* were evaluated as ~300, 140, and 116 nm for the PBT8020, PCT6040, and PZT3070 thin films, respectively. Meanwhile, AFM images obtained for a PCT6040/Pt (111)/Ti/SiO₂/Si (100) thin film reported an $R_{\rm rms}$ value of 4 nm and a *t* value of 70 nm, such film was heat-treated in a conventional furnace.¹⁷ In this sense, the sample grown on LNO/LAO structures seems to display a higher $R_{\rm rms}$ and big-



Fig. 3. Frequency dependence of the dielectric constant and dielectric loss of the (a) $Pb_{0.8}Ba_{0.2}TiO_3$; (b) $Pb_{0.6}Ca_{0.4}TiO_3$; and (c) $PbZr_{0.30}Ti_{0.70}O_3$ thin films.

ger average grain size than those reported for the ABO₃ thin films deposited on Pt-based substrates.

The combined results showed above indicated that the annealing process and the use of high-oriented LNO/LAO structures promoted changes in both size and morphology of the grains, and also allowed the production of highly oriented ABO₃ thin films. As these features have a close relation to the dielectric properties, the films were characterized by means of the measurements of the constant dielectric and dielectric

loss as a function of frequency. The dielectric constant (κ) and dielectric loss (tan δ) as a function of frequency characterization obtained for these films on LNO/LAO structures are shown in Fig. 3. These curves show a smooth decrease of the dielectric constant with the increasing of the frequency. The κ values observed for PBT8020 and PCT6040 thin films coated on LNO/LAO are significantly higher than those reported in literature.^{15,17–19} In fact, at 100 KHz these films presents κ values close to 2250 and 930, respectively, while films grown on platinum electrodes presents κ values of ~118 and 200 observed for similar PBT and PCT films, respectively. However, the PZT3070 deposited on LNO/LAO presents κ values considerably lower than those reported for similar films also grown on LNO/ALO structures.¹⁹ These works reported κ values from 597 to 1250 for PZT50/50 and PZT53/47, while we observe κ values of \sim 330 at 100 kHz. We believed that such behavior could be a result of the lack of preferential orientation of this films, as is shown in the X-ray data. Beside, the enhance of the dielectric constant observed for the other films could be due to the improvement between the ABO₃ thin film and the LaNiO₃ electrode interface, which could promote the formation of a highly oriented ABO₃/LaNiO₃/LaAlO₃ structure. In this sense, we believe that the microwave oven treatments suppress the formation of a very low dielectric constant layer at the thin film/electrode interface, which sometimes is the main cause of the lower values of the dielectric constant related to many ferroelectric thin films.^{20,21}

4. Conclusion

In summary, we have produced high-oriented ABO₃/LNO/LAO structures by a wet soft chemical method and using heat treatments at a microwave oven. This study indicated that the ABO₃ thin films on LNO bottom electrodes present excellent structural, microstructural, and electrical properties. The A with Ba, and Ca presents a higher dielectric constant, which make them a very attractive candidate to many applications. Moreover, the remarkable improvement in all the properties suggested that the chemical route combined with the annealing by a microwave oven process is an alternative approach to obtaining thin films with a quality comparable to the best thin films, suitable for integrated device applications, and processed by conventional methods.

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